Thermal TGF0200LD

Thermal TGF0200LD is a kind of two-component thermal conductive gel with high thermal conductivity, low compression stress and excellent reliability performance. The material provides good gap filling ability and could be used for automatic dispensing and screen printing. The material can be cured under room or high temperature to form elastic pad after curing.

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Property	Typical Value	Unit	Test Method
Composition	Silicone Filled with Thermal Powder &		—
Color	A – Red B – White Mix – Red		Visual
Thermal Conductivity	2.0	W/m·K	ASTM D5470
Flow Rate (A/B)	70	g/min	30cc EFD, 90P
Density	2.0		

All technical information stated in this technical data have been confirmed that all the technical parameters are reliable after hard EMC /P <</MCID 9 >>BDC -1

Power Supply Controller

SmartWearable Product